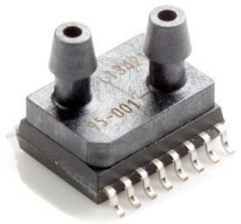
Medium Pressure Sensor
Digital Output

AccuStable SM3041 Series

FEATURES

- Fully digital, pressure calibrated and temperature compensated output
- I^2C Digital Interface
- Compensated temperature range: -20 to +85°C
- Better than 1% initial accuracy and less than 1% accuracy shift over life
    - (<1% shift over 1000hr HTOL)
- Differential pressure configuration
- Custom pressure ranges available
- Insensitive to mounting orientation
- Manufactured according to ISO9001 and ISO/TS 16949 standards
- Pressure ranges from -15 to 15 PSI



DESCRIPTION

The SM3041 Series is a digital, medium pressure MEMS sensor family offering state-of-the-art pressure transducer technology and CMOS mixed signal processing technology to produce a digital, fully signal conditioned, multi-order pressure and temperature compensated sensor in JEDEC standard SOIC-16 package with a dual vertical porting option. It is available as a differential sensor or with custom pressure ranges.

Combining the pressure sensor with a signal-conditioning ASIC in a single package simplifies the use of advanced silicon micro-machined pressure sensors. The pressure sensor can be mounted directly on a standard printed circuit board and a high level, calibrated pressure signal can be acquired from the digital interface. This eliminates the need for additional circuitry, such as a compensation network or microcontroller containing a custom correction algorithm.

The SM3041 is shipped in sticks or tape & reel.

Medical	Industrial	Consumer
Ventilators	Gas Flow instrumentation	Sport Equipment
Oxygenators	Pneumatic Gages	Appliances
Fluid Evacuation	Pressure Switches	
Gas Flow Instrumentation	Life Sciences	
Patient Monitoring		
Blood Pressure Monitor		
Negative Pressure Wound Therapy		

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Absolute Maximum Ratings

No.	Characteristic	Symbol	Minimum	Typical	Maximum	Units
1	Supply Voltage	V_{DD}	0.0	-	6.0	V
2	Supply Current	I_{DD}	0.0	2.0	4.0	mA
3	Update Period				2	ms
4	Operating Temperature[a]	T_{OP}	-20		+85	°C
5	Storage Temperature[a]	T_{STG}	-40		+125	°C

Notes:
a. Tested on a sample basis.

No.	Product Number	Operating Pressure	Proof Pressure (P_{PROOF})[a]	Burst Pressure (P_{BURST})[a]
6	SM3041-005-D-C-3-S	-5 to 5 PSI	25 PSI	40 PSI
7	SM3041-015-D-C-3-S	-15 to 15 PSI	45 PSI	75 PSI

Notes:
a. Tested on a sample basis.

Operating Characteristics - Specifications

All parameters are specified at Vdd = 3.3 V supply voltage at 25°C, unless otherwise noted.

No.	Characteristic	Symbol	Minimum	Typical	Maximum	Units
8	Supply Voltage	V_{DD}	3.0	3.3	3.6	V
9	Pressure Output @ P_{MIN}	OUT_{MIN}		1,638		Counts
10	Pressure Output @ P_{MAX}	OUT_{MAX}		14,745		
11	Full Scale (P_{MIN} to P_{MAX}) Span	FSP		13,107		
12	Resolution			14		Bits
13	Accuracy [b]	ACC	-1		+1	%FS
14	Compensated Temperature Range	T_{COMP}	-20		+85	°C

Notes:
b. The accuracy specification applies over all operating conditions. This specification includes the combination of linearity, repeatability, and hysteresis errors over pressure, temperature, and voltage.

SM3041 – I²C Communications

1. SCL Clock frequency:

- 100kHz to 400kHz

2. Slave Address

- The factory setting for the I²C slave address is 28HEX. The part will only respond to the set address.

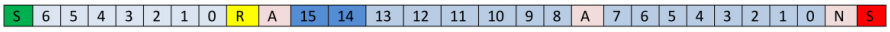
3. Read Operations

- For read operations, the I²C master command starts with the 7-bit slave address with the 8th bit = 1 (READ). The SM3041 as the slave sends an acknowledge (ACK) indicating success.
- The SM3041 has four I²C read commands: Read_DF2, Read_DF3, and Read_DF4. The following figures show the structure of the measurement packet for three of the four I²C read commands, which are further explained below.

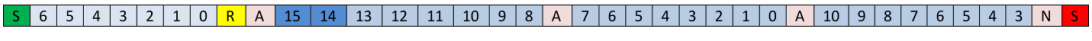
3.1 I²C Read_DF (Data Fetch):

- For the Data Fetch commands, the number of data bytes returned by the SM3041 is determined by when the master sends the NACK and stop condition.
- For the Read_DF3 data fetch command (Data Fetch 3 Bytes), the SM3041 returns three bytes in response to the master sending the slave address and the READ bit (1): two bytes of bridge data with the two status bits as the MSBs and then 1 byte of temperature data (8-bit accuracy). After receiving the required number of data bytes, the master sends the NACK and stop condition to terminate the read operation.
- For the Read_DF4 command, the master delays sending the NACK and continues reading an additional final byte to acquire the full corrected 11-bit temperature measurement. In this case, the last 5 bits of the final byte of the packet are undetermined and should be masked off in the application.
- The Read_DF2 command is used if corrected temperature is not required. The master terminates the READ operation after the two bytes of bridge data.

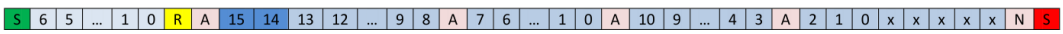
- I2C Read_DF2 – Data Fetch 2 Bytes:
  - Slave returns only pressure data to the master in 2 bytes.
  - Start Condition – Device Slave Address [6:0] – Read/Write Bit (Read = 1) – Wait for Slave ACK – 2 status bits – 6 pressure bits [13:8] – Master ACK – 8 pressure bits [7:0] – Master NACK – Stop Condition

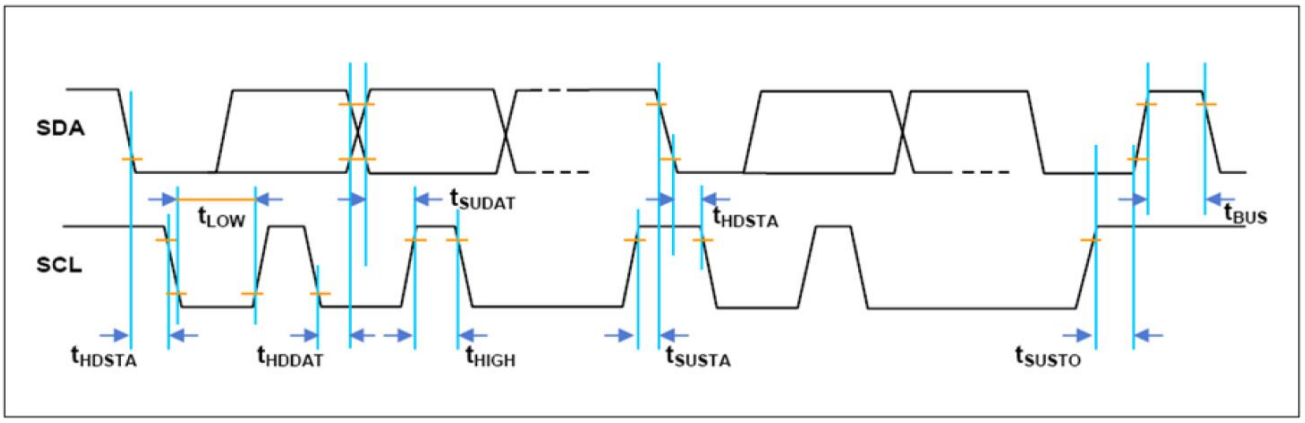


- I2C Read_DF3 – Data Fetch 3 Bytes:
  Slave returns 2 pressure data bytes and temperature high byte [10:3] to the master.
  Start Condition – Device Slave Address [6:0] – Read/Write Bit (Read = 1) – Wait for Slave ACK – 2 status bits – 6 pressure bits [13:8] – Master ACK – 8 pressure bits [7:0] – Master ACK – 8 temperature bits [10:3] – Master NACK – Stop Condition



- I2C Read_DF4 – Data Fetch 4 Bytes:
  - Slave returns 2 pressure data bytes and and 2 temperature bytes ([10:3] and [2:0]xxxxx) to the master.
  - Start Condition – Device Slave Address [6:0] – Read/Write Bit (Read = 1) – Wait for Slave ACK – 2 status bits – 6 pressure bits [13:8] – Master ACK – 8 pressure bits [7:0] – Master ACK – 8 temperature bits [10:3] – Master ACK – 3 temperature bits [2:0] – Master NACK – Stop Condition





Parameter	Symbol	Minimum	Typical	Maximum	Units
SCL Clock Frequency	FSCL	100		400	kHz
Start Condition Hold Time Relative to SCL Edge	tHDSTA	0.1			µs
Minimum SCL Clock Low Width1	tLOW	0.6			µs
Minimum SCL Clock High Width1	tHIGH	0.6			µs
Start Condition Hold Time Relative to SCL Edge	tSUSTA	0.1			µs
Data Hold Time on SDA Relative to SCL Edge	tHIDDAT	0.0			µs
Data Setup Time on SDA Relative to SCL Edge	tSUDAT	0.1			µs
Stop Condition Setup Time on SCL	tSUSTO	0.1			µs
Bus Free Time Between Stop Condition and Start Condition	tBUS	2.0			µs

5. Differences SM3041 I²C Protocol vs. Original I²C protocol

- ***Note: There are three differences in the SM3041 protocol compared with the original I²C protocol***

- Sending a start-stop condition without any transitions on the CLK line (no clock pulses in between) created a communication error for the next communication, even if the next start condition is correct and the clock pulse is applied. An additional start condition must be sent, which results in restoration of proper communication.

- The restart condition - a falling SDA edge during data transmission when the CLK clock line is still high - creates the same situation. The next communication fails, and an additional start condition must be sent for correct communication.

- A failing SDA edge is not allowed between the start condition and the first rising SCL edge. If using an I²C address with the first bit 0, SDA must be held low from the start condition though the first bit.

6. Diagnostic Features – Status Bits

The SM3041 offers diagnostic features to ensure robust system operation. The diagnostic states are indicated by a transmission of the status of the 2 MSBs of the pressure high byte data.

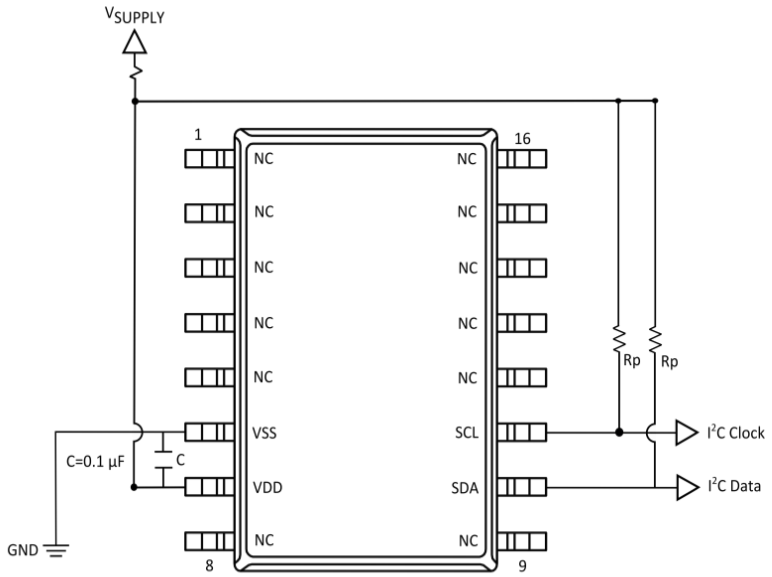
Status Bits (2 MSBs of Output Packet)	Symbol
00	Normal operation, good data packet
01	Device in Command Mode (not applicable for normal operation)
10[(1)]	Stale data: Data that has already been fetched since the last measurement cycle
11	Diagnostic condition exists

Note[(1)]**:** If a data fetch is performed before or during the first measurement after power-on reset, then "stale" will be returned, but this data is actually invalid because the first measurement has not been completed.

- When the two MSBs are 11, one of the following faults listed below is indicated:
  - Invalid EEPROM signature
  - Loss of bridge positive or negative
  - Bridge input short
  - Loss of bridge source

- All diagnostics are detected in the next measurement cycle and reported in the subsequent data fetch. Once a diagnostic is reported, the diagnostic status bits will not change unless both the cause of the diagnostic is fixed and a power-on-reset is performed.

SM3041 + Family Applications Circuit



"C" needs to be in close proximity of the device

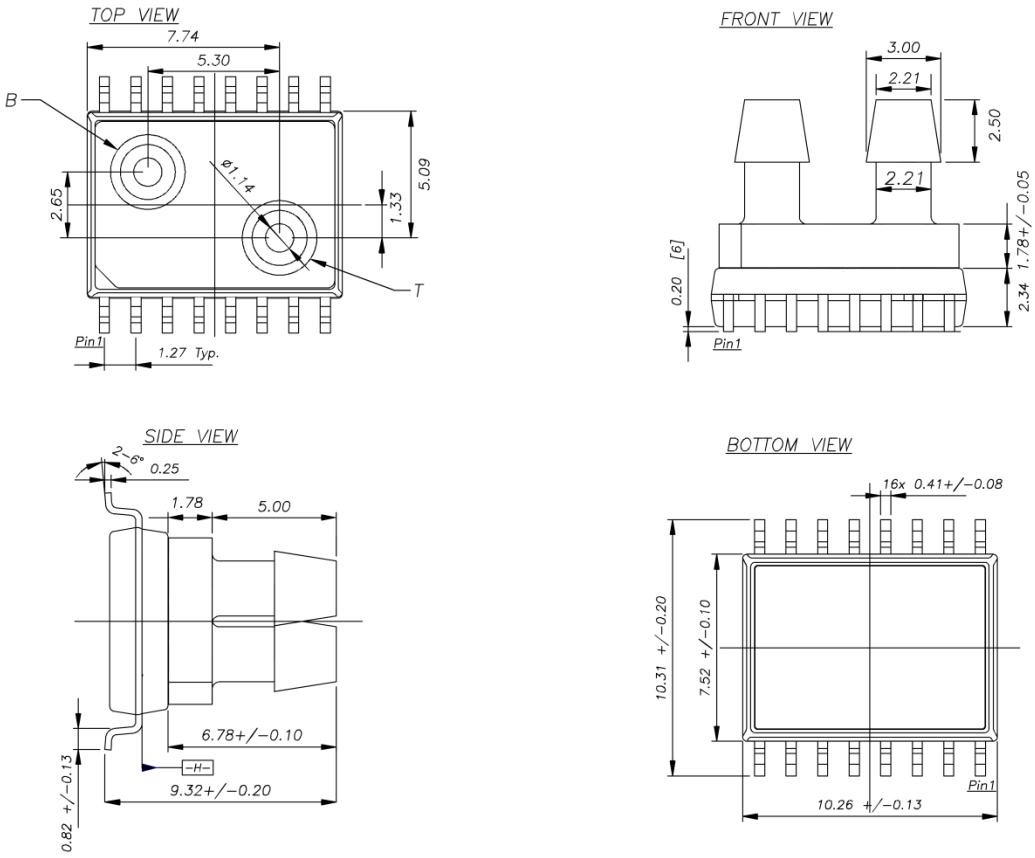
Rp = Pull-up Resistors
For Example: 4.7 kΩ Resistors

Package Labeling	
Pin No.	Pin Function
1	NC
2	NC
3	NC
4	NC
5	NC
6	GND
7	VDD
8	NC
9	NC
10	SDA
11	SCL
12	NC
13	NC
14	NC
15	NC
16	NC

NOTES:

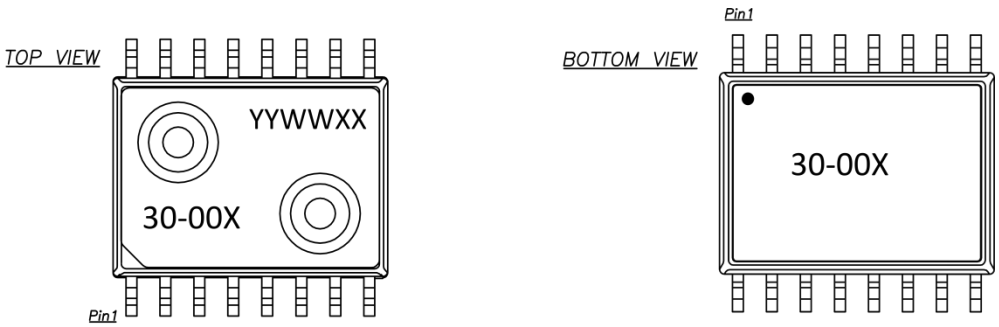
- Do not connect to NC pins

SOIC-16 Package Dimensions



- All dimensions in units of [mm]
- Moisture Sensitivity Level (MSL): Level 3
- Wetted materials: Silicon, glass, copper, silicone, epoxy, mold compound.
- Tolerance on all dimensions ±0.13 mm unless otherwise specified.
- [B] is tube connected to bottom side of sensor die.
- [T] is tube connected to top side of sensor die. Topside pressure is positive pressure. An increase in topside pressure will result in an increase in sensor output.

Part & Lot Number Identification



-0XX = 001, 002 for pressure ranges 5, 15 PSI

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Ordering Information

Product Number	Part Marking	Minimum Pressure	Maximum Pressure	Pressure Type	Port Configuration	Shipping Method
SM3041-005-D-C-3-S	30 – 001	-5 PSI	+5 PSI	Differential	Dual Vertical	45 Units (per stick)
SM3041-015-D-C-3-S	30 – 002	-15 PSI	+15 PSI			

Part Number Legend

SM 3041 005_ D C 3 S

- SM: Silicon Microstructures
- 3041: Product Series
- 005_: Rated Pressure
  - Unit of Pressure
  - C : cmH_2O
  - M : mBar
  - K : kPa
  - None : PSI
- D: Pressure Type
  - D: Differential
- C: Port Configuration
  - C: Vertical Port
- 3: Supply Voltage
  - 3 : 3.3 V
- S: Shipping Configuration
  - S - Sticks/Tubes
  - T - T & R

Qualification Standards

REACH Compliant
RoHS Compliant
PFOS/PFOA Compliant
For qualification specifications, please contact Sales at sales@si-micro.com

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